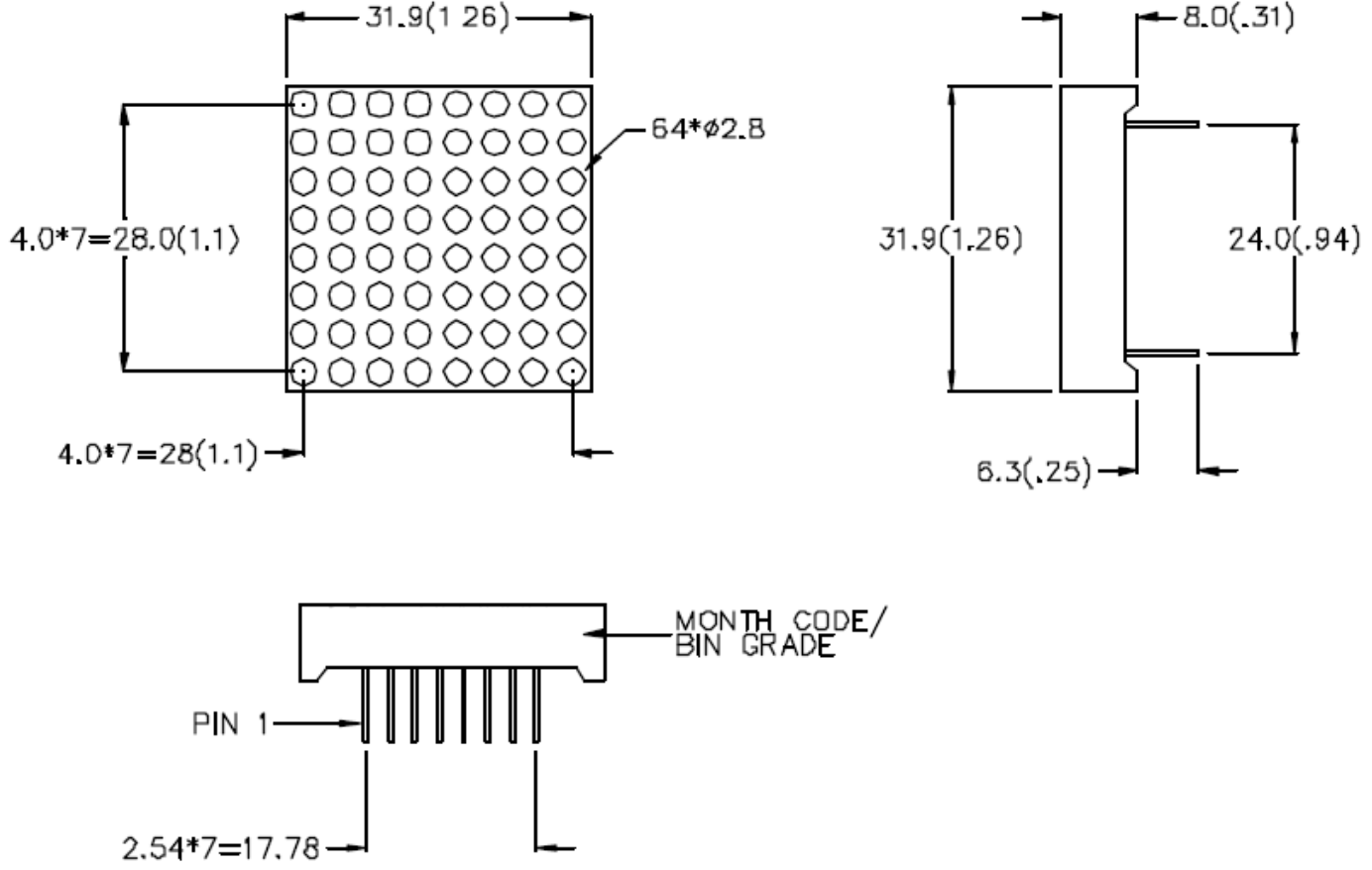
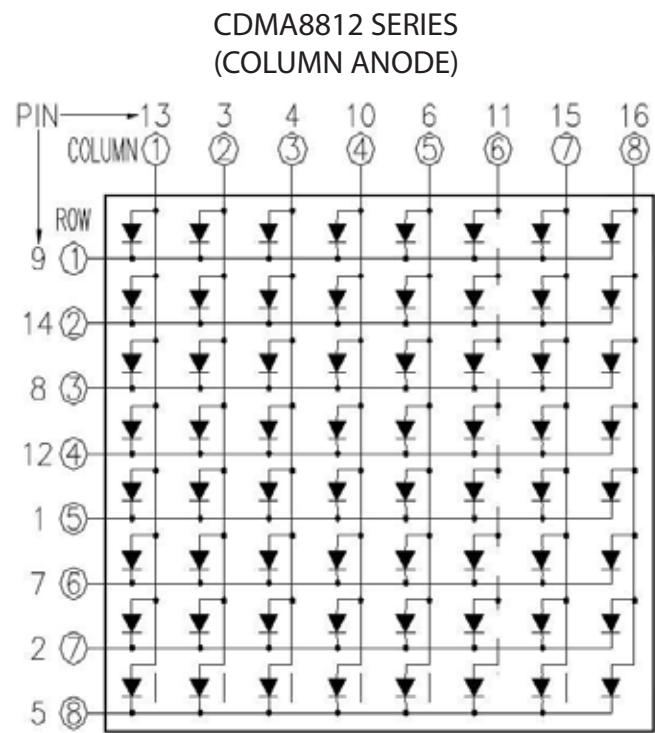
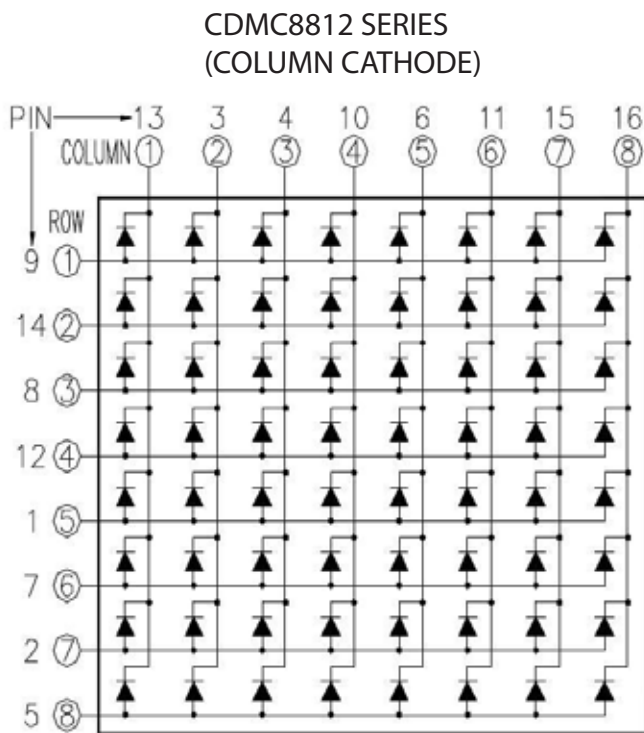


SPECIFICATIONS **CDMX8812 SERIES**
PACKAGE DIMENSIONS


- Notes:
1. All dimensions are in millimeters (inches).
 2. Tolerance is $\pm 0.25\text{mm}$ (0.01") unless otherwise noted.
 3. Specifications are subject to change without notice.



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SPECIFICATIONS
INTERNAL CIRCUIT DIAGRAM

Notes:

1. All dimensions are in millimeters (inches).
2. Tolerance is $\pm 0.25\text{mm}$ (0.01") unless otherwise noted.
3. Specifications are subject to change without notice.



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PART NUMBER DESCRIPTION

Part Number	Chip Material	Color of Emission	Lens Type	Description
CDMA8812R1W	GaAsP	Red	White Segment	Common Anode
CDMC8812R1W	GaAsP	Red	White Segment	Common Cathode
CDMA8812RR1W	AlGaAs	Super Red	White Segment	Common Anode
CDMC8812RR1W	AlGaAs	Super Red	White Segment	Common Cathode
CDMA8812Y1W	GaAsP	Yellow	White Segment	Common Anode
CDMC8812Y1W	GaAsP	Yellow	White Segment	Common Cathode
CDMA8812G1W	GaP	Green	White Segment	Common Anode
CDMC8812G1W	GaP	Green	White Segment	Common Cathode

OPTICAL-ELECTRICAL CHARACTERISTICS
(TA=25°C)

Part Number	Wave-length (nm)	Absolute Maximum				Electro-Optical Characteristics					
		$\Delta\lambda$	P_D	I_{AF}	I_{PF}	V_F (V)			I_F	I_v (μ cd)	
		nm	mW	mA	(Peak)	Min	Typ	Max	(Rec)	Min	Typ
CDMA8812R1W	625	45	75	30	100	1.7	1.85	2.5	10	1900	6400
CDMC8812R1W	625	45	75	30	100	1.7	1.85	2.5	10	1900	6400
CDMA8812RR1W	640	20	72	20	100	1.6	1.75	2.4	10	4000	13000
CDMC8812RR1W	640	20	72	20	100	1.6	1.75	2.4	10	4000	13000
CDMA8812Y1W	588	35	75	30	100	1.7	2.1	2.8	10	1200	4700
CDMC8812Y1W	588	35	75	30	100	1.7	2.1	2.8	10	1200	4700
CDMA8812G1W	568	30	65	30	100	1.7	2.1	2.8	10	1900	8000
CDMC8812G1W	568	30	65	30	100	1.7	2.1	2.8	10	1900	8000

ABSOLUTE MAXIMUM RATINGS
(TA=25°C)

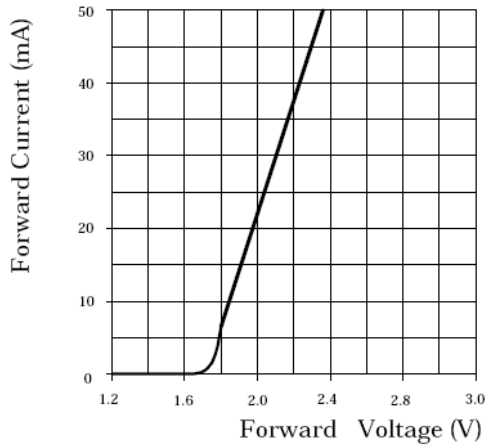
Reverse Voltage	5V	Spectral Line half-width (λ)	nm
Reverse Current ($V_r = 5V$)	100 μ A	Power Dissipation (P_D)	mW
Operating Temperature	-40°C~+85°C	Peak Forward Current (Duty 1/10, @ KHz)	mA
Storage Temperature	-40°C~+85°C	Recommended Operation Current (I_F Rec)	mA
Soldering Temperature	250C~260C for 3 sec.	Average Luminous Intensity ($I_F=10$)	μ A



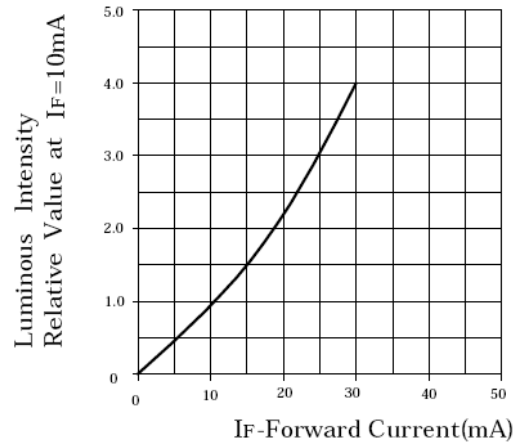
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OPTICAL CHARACTERISTIC CURVES - RED

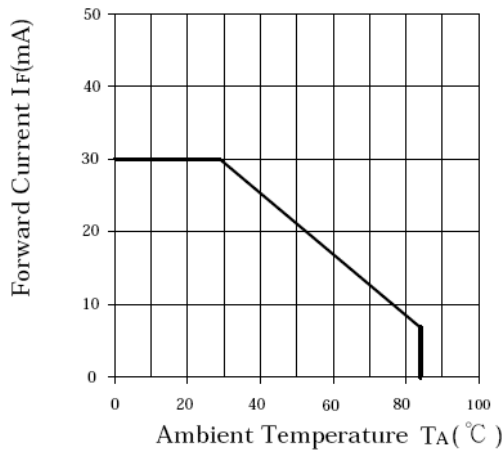
Forward Current vs. Forward Voltage



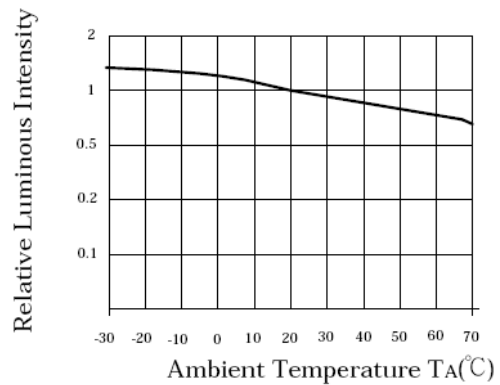
Relative Intensity vs. Forward Current



Forward Current vs. Ambient Temperature



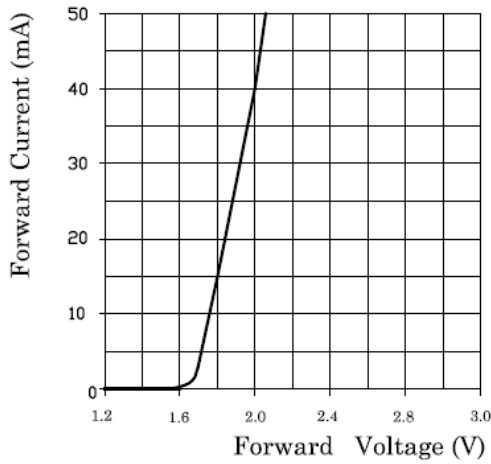
Luminous Intensity vs. Ambient Temperature



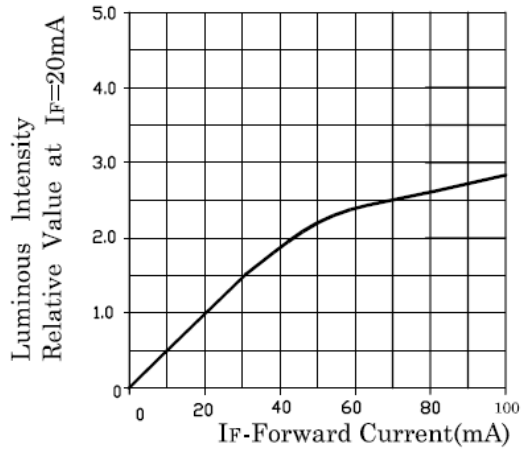
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OPTICAL CHARACTERISTIC CURVES - SUPER RED

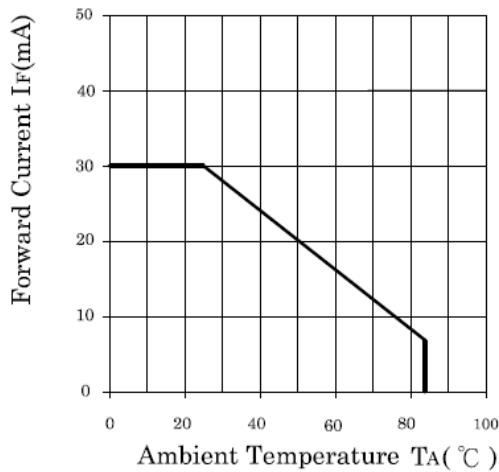
Forward Current vs. Forward Voltage



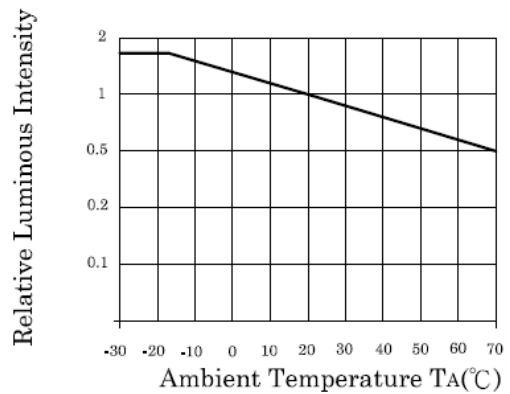
Relative Intensity vs. Forward Current



Forward Current vs. Ambient Temperature



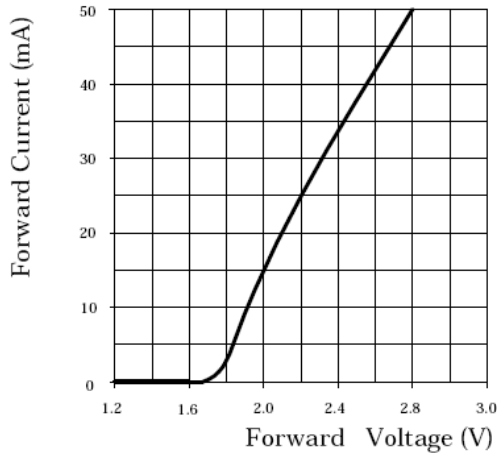
Luminous Intensity vs. Ambient Temperature



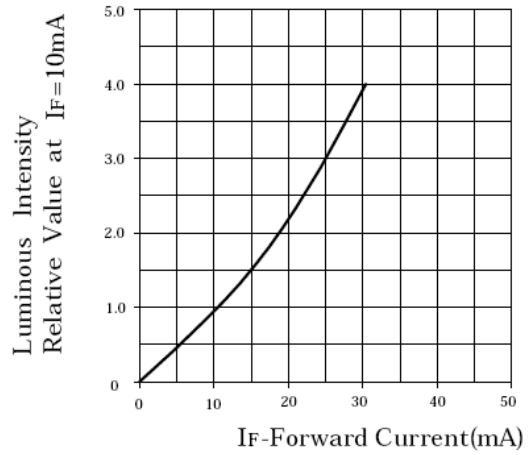
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OPTICAL CHARACTERISTIC CURVES - YELLOW

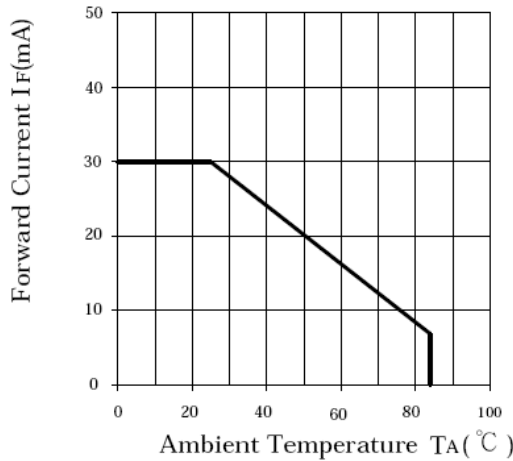
Forward Current vs. Forward Voltage



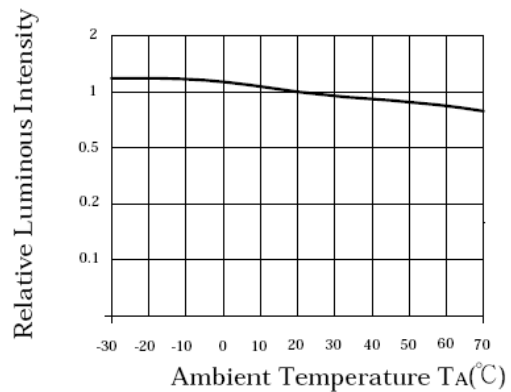
Relative Intensity vs. Forward Current



Forward Current vs. Ambient Temperature



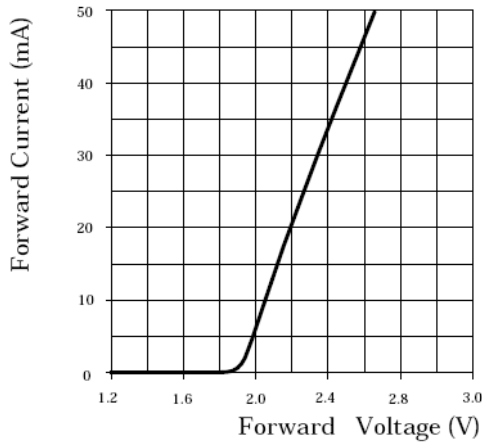
Luminous Intensity vs. Ambient Temperature



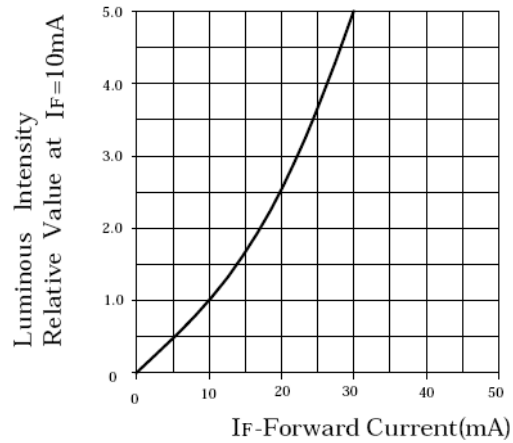
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OPTICAL CHARACTERISTIC CURVES - GREEN

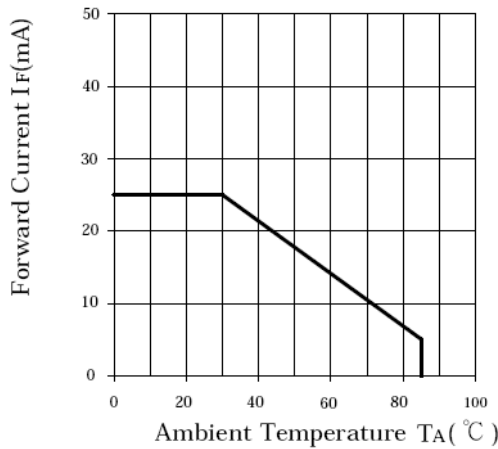
Forward Current vs. Forward Voltage



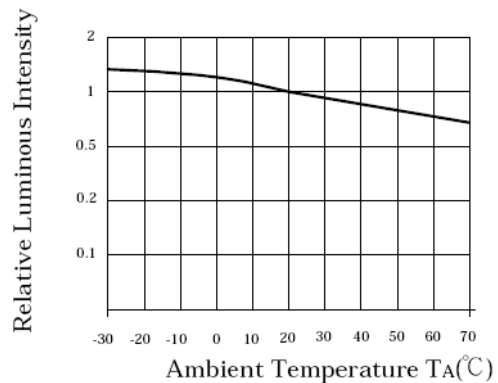
Relative Intensity vs. Forward Current



Forward Current vs. Ambient Temperature



Luminous Intensity vs. Ambient Temperature



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SOLDERING CONDITIONS - DISPLAY

* Solder the LED no closer than 3mm from the base of the epoxy bulb. Soldering beyond the base of the tie bar is recommended.

* Recommended soldering conditions

Dip Soldering	
Pre-Heat	100 °C Max
Pre-Heat Time	60 Second Max
Solder Bath Temperature	260 °C Max
Dipping Time	5 Second Max
Dipping Position	No lower than 3mm from the base of the epoxy

Hand Soldering		
	3mm Series	Others
Temperature	300 °C Max	350 °C Max
Soldering Time	3 Second Max	3 Second Max
Position	No closer than 3mm from the base of the epoxy	No closer than 3mm from the base of the epoxy

* Do not apply any stress to the lead. Particularly when heated.

* The LED must not be repositioned after soldering.

* After soldering the LEDs, the epoxy bulb should be protected from mechanical shock or vibration until the LEDs return to room temperature.

* Direct soldering onto a PC board should be avoided. Mechanical stress to the resin may be caused by the PC board warping or from the clinching and cutting of the leadframes. When it is absolutely necessary, the LEDs may be mounted in this fashion, but, the user will assume responsibility for any problems. Direct soldering should only be done after testing has confirmed that no damage, such as wire bond failure or resin deterioration, will occur. LEDs should not be soldered directly to double sided PC boards because the heat will deteriorate the epoxy resin.

* When it is necessary to clamp the LEDs to prevent soldering failure, it is important to minimize the mechanical stress on the LEDs.

* Cut the LED leadframes at room temperature. Cutting the leadframes at high temperature may cause LED failure.



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